

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Takayuki TSUKIZAWA et al. Application No.: 10/596,312 Confirmation No.: 5223 Filing or 371(c) Date: June 8, 2006 Title: METHOD FOR MANUFACTURING CHIP ELECTRONIC COMPONENT- MOUNTED CERAMIC SUBSTRATE (AS AMENDED)	Art Unit: 3729 Examiner: T. Phan
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AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated May 7, 2009, please amend the above-identified application as follows:

☒ **Amendments to the Specification** begin on page **2** of this paper.

☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page **4** of this paper.

☐ **Amendments to the Drawings** begin on page of this paper and include an attached replacement sheet. An **Appendix** including the amended drawing figures is attached following page of this paper.

☒ **Remarks/Arguments** begin on page **7** of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.